

1. Introduction

generated in No-Insulation (NI) REBa₂Cu₃O₇- $_x$ (REBCO, RE = Rare Earth) pancake coils.

coil-radial current in the The magnetic field generates the Lorentz in the coil-circumferential force direction *i.e.* torque.

We present the numerical-simulation behaviors of the torque of the generated in the <u>NI REBCO double</u> pancake coil after quench.

2. Simulation Method

In the circuit analysis, the current is computed with the PEEC method [], [], and then the Joule heating inside the pancake is obtained as an input of thermal analysis. The thermal analysis is performed to obtain the temperature distribution, and it determines the properties of REBCO tape, such as the critical current.



The PEEC model extended to a double pancake and a multiple-stacked double pancake.

Thermal Analysis (Finite Element Method) Governing Equation:





Fig. 3. Schematic drawings of simulation mode

TABLE II SIMULATION CONDITIONS

Parameters	Values
Time step [s]	0.1
Simulation time [s]	50.0
Operating current [A]	500
External magnetic field, axial ,radial [T]	10.0, 0.0
Operating temperature [K]	20





expressed as follows:

$$I_{L_{i}} - I_{L_{i-1}} + I_{ct_{i}} - I_{ct_{i-d}} =$$

$$\sum_{j=i}^{i-d-1} \left(\sum_{k=0}^{n} M_{jk} \frac{I_{L,k} - I_{L,k}^{-1}}{\Delta t} + I_{L,j} \frac{R_{s}}{R_{sc,k}} \right)$$

resistance

_	Parameters	Values
	REBCO tape	9
	REBCO tape width [mm]	4.0
	REBCO tape Thickness [mm]	0.096
Ι.	Copper stabilizer thickness [mm]	20.0
	REBCO layer thickness [µm]	1.0
	$I_{\rm c}$ @ 77 K, self-field [A]	115.0
	Double pancake	coil
	Coil inner radius [mm]	50,100, 500,1000
	Number of turns (each pancake)	100
	Coil thickness [mm]	9.6
	Flange (insulator) width [mm]	1.0
	Contact resistivity [$\mu\Omega$ m^{2}]	70.0

small-size coil, the torque in the direction opposite to the torque initially generated is gradually generated. When the very large-size coil, the sudden inversion of torque is generated.